

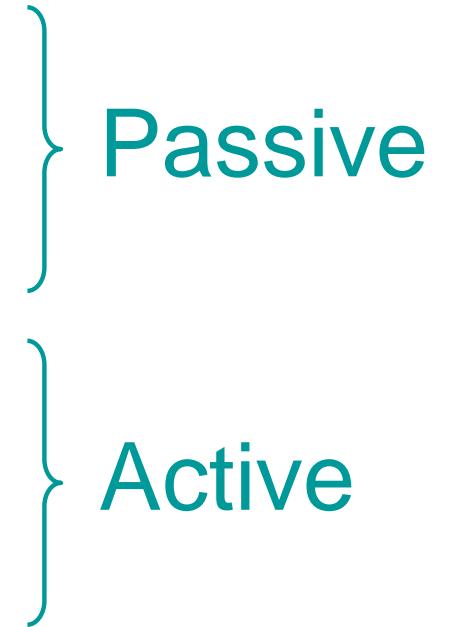
# Passive and Active Actuation of Droplet Motion

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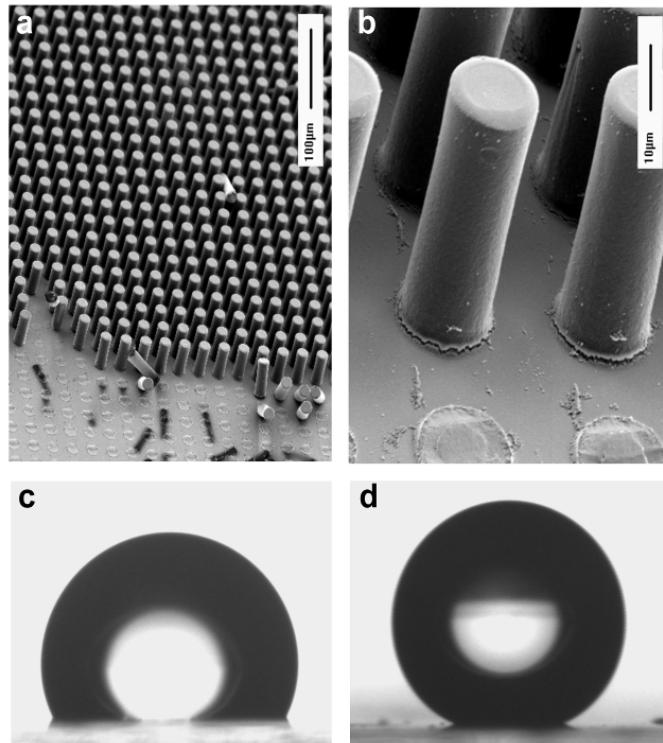
# Overview

- 1. Superhydrophobicity
  - 2. Gradients in Superhydrophobicity
  - 3. Electrowetting
  - 4. Moving Liquid Marbles
- 
- Passive
- Active

# Superhydrophobicity

# Surface Structure

## Effect on Water



a), b) Pillars  $D=15 \mu\text{m}$ ,  $L = 2D$

c) Flat and hydrophobic

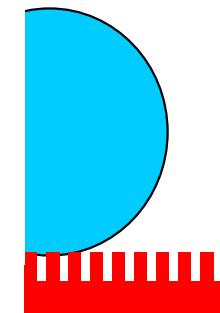
d) Tall and hydrophobic

## “Skating” Droplets

Composite air-solid surface

(Cassie-Baxter)

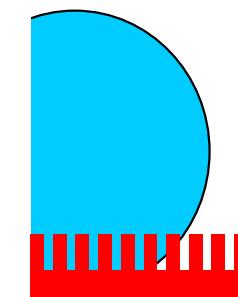
Low hysteresis: “Slippy” surface



## “Penetrating” Droplets

Based on roughness (Wenzel)

Large hysteresis: “Sticky” surface

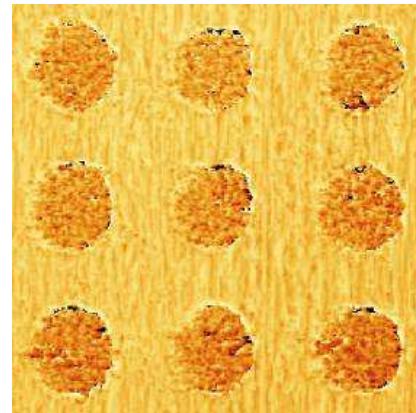


# Electrodeposited Surfaces

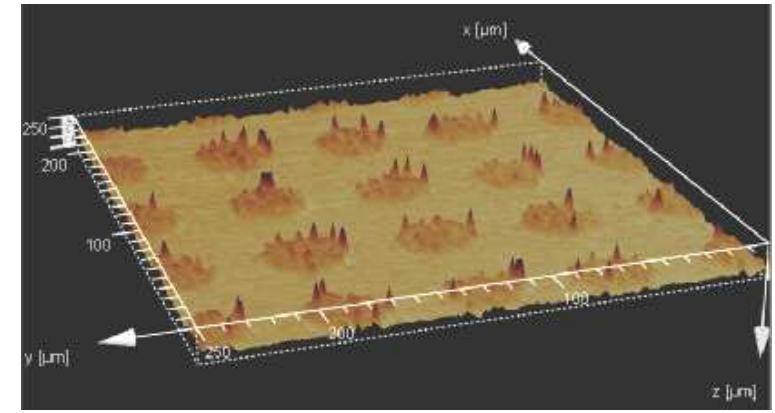
Diffusion limited aggregation –copper acid bath, fractal roughness



*Base Cu electroplated surface*

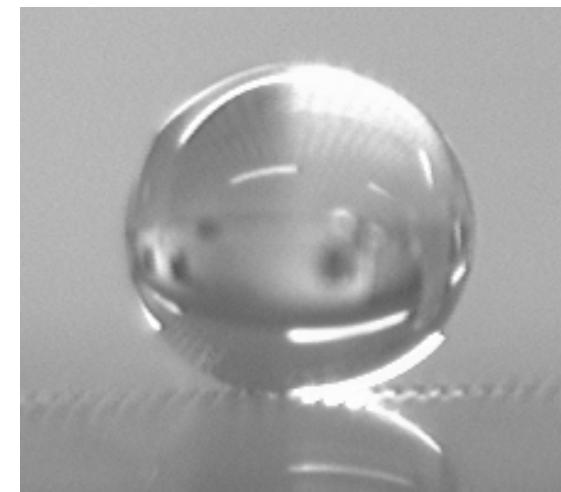
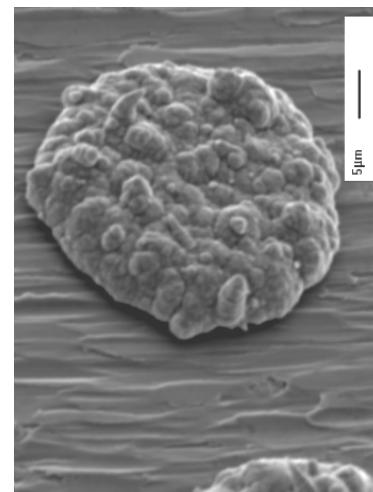
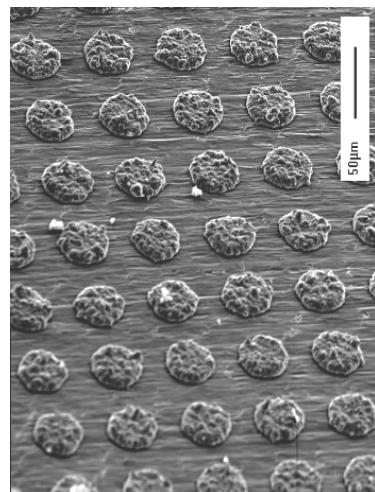


*Confocal image of a 30 μm textured electroplated Cu*



*3D view of a electroplated copper sample*

“Chocolate Chip Cookies” - Electroplating through a mask



Reference Shirtcliffe *et al*, Adv. Maters. 16 (2004) 1929-1932; Shirtcliffe *et al*, Langmuir 21 (2005) 937-943.

# Gradients in Superhydrophobicity

# Driving Force

## Local Cassie-Baxter Contact Angle

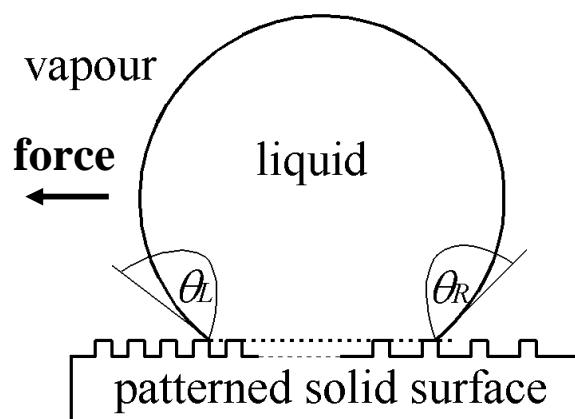
Make contact angle depend on position and surface chemistry  $\theta(x, \theta_e^s)$

Same surface chemistry, but vary Cassie-Baxter fraction across surface

$$\cos \theta_{CB}(x) = f(x) \cos \theta_e^s - (1-f(x))$$

## Driving Force

Droplet experiences different contact angles  $\Rightarrow$  driving force



$$\begin{aligned} \text{Force} &\propto \gamma_{LV}(\cos \theta_R - \cos \theta_L) \\ &\propto \gamma_{LV}(f_R - f_L)(\cos \theta_e^s + 1) \end{aligned}$$

*Need to overcome contact  
angle hysteresis*

# Conditions for Motion

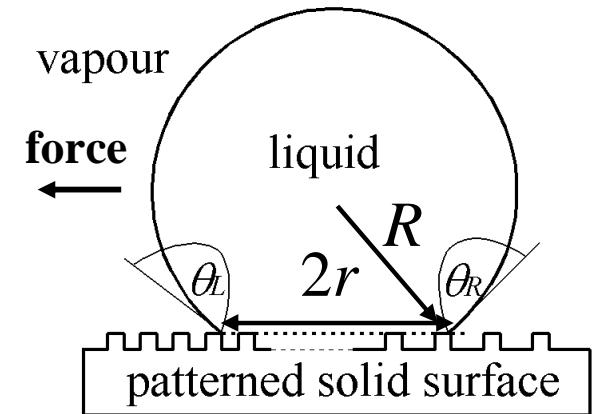
## Spherical Cap

Assume small contact area:

$$2r \approx 2R [2f_{\text{ave}}(x)(1 + \cos \theta_e^s)]^{1/2}$$

$$\text{Force/length} = \gamma_{LV}(f_R - f_L)(\cos \theta_e^s + 1)$$

$$= 2R \gamma_{LV}[2f_{\text{ave}}(x)]^{1/2}(1 + \cos \theta_e^s)^{3/2}(\frac{df}{dx})$$



## Defect Based Hysteresis Force

$$\text{Force/length} = \gamma_{LV}\Delta(\cos \theta) \approx \gamma_{LV}f(x)\log f(x)$$

## Drive Condition

$$(\frac{df}{dx}) > \text{constant} \times f_{\text{ave}}(x)^{1/2} \log f_{\text{ave}}(x) / [R(1 + \cos \theta_e^s)^{3/2}]$$

More  
superhydrophobic

Larger  
droplets

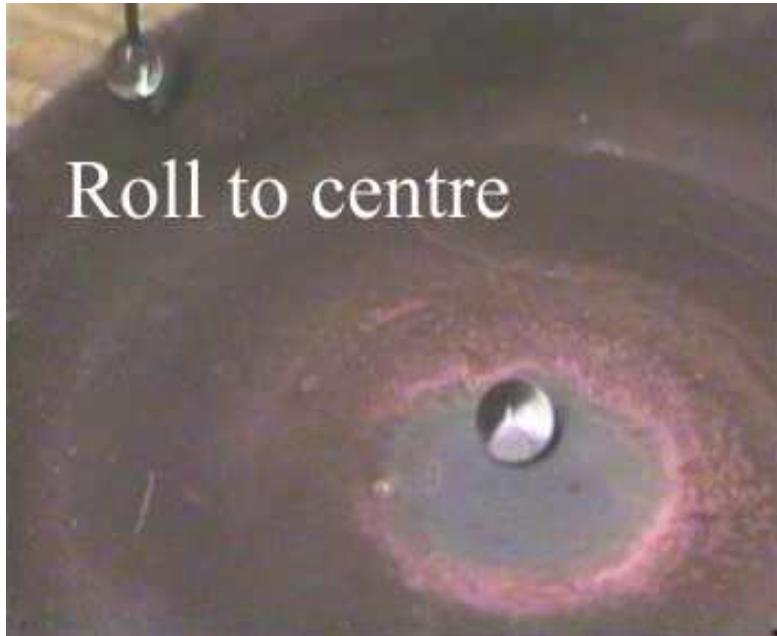
# Self-Actuated Motion

## Radial Gradient in Contact Angle

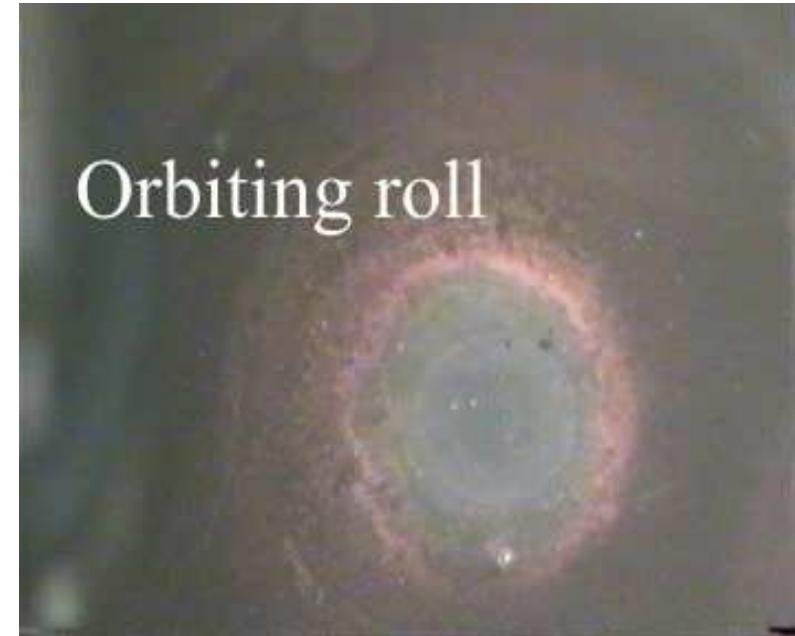
Electrodeposited copper – Diffusion limited aggregation

Fractal-like to overcome contact angle hysteresis

Radial gradient  $\theta(r) = 110^\circ \rightarrow 160^\circ$



Roll to centre



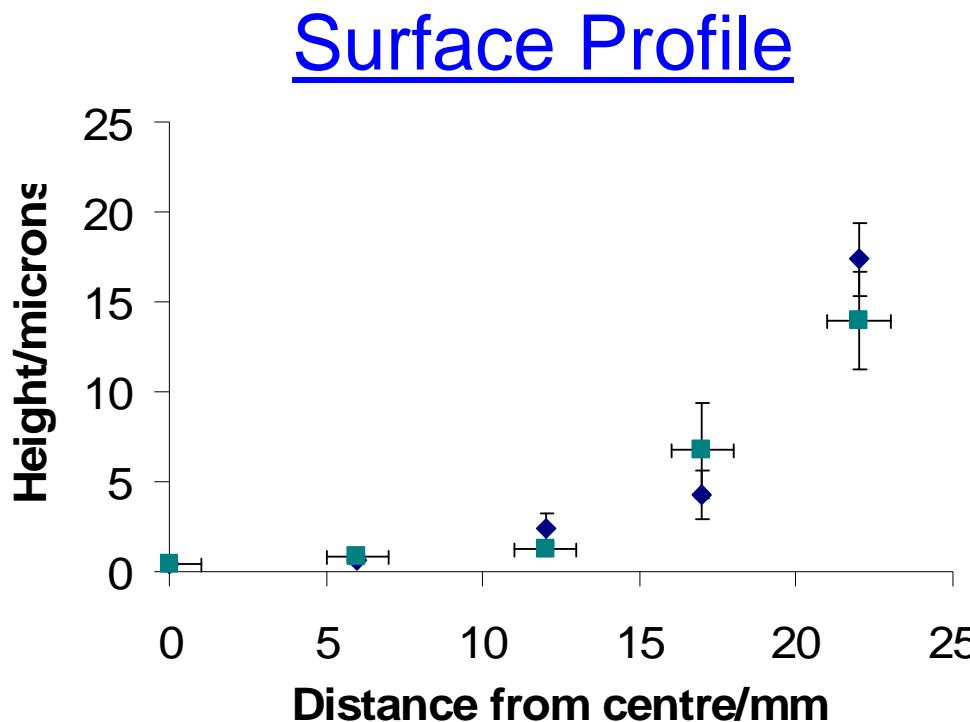
Orbiting roll

# Surface Profile

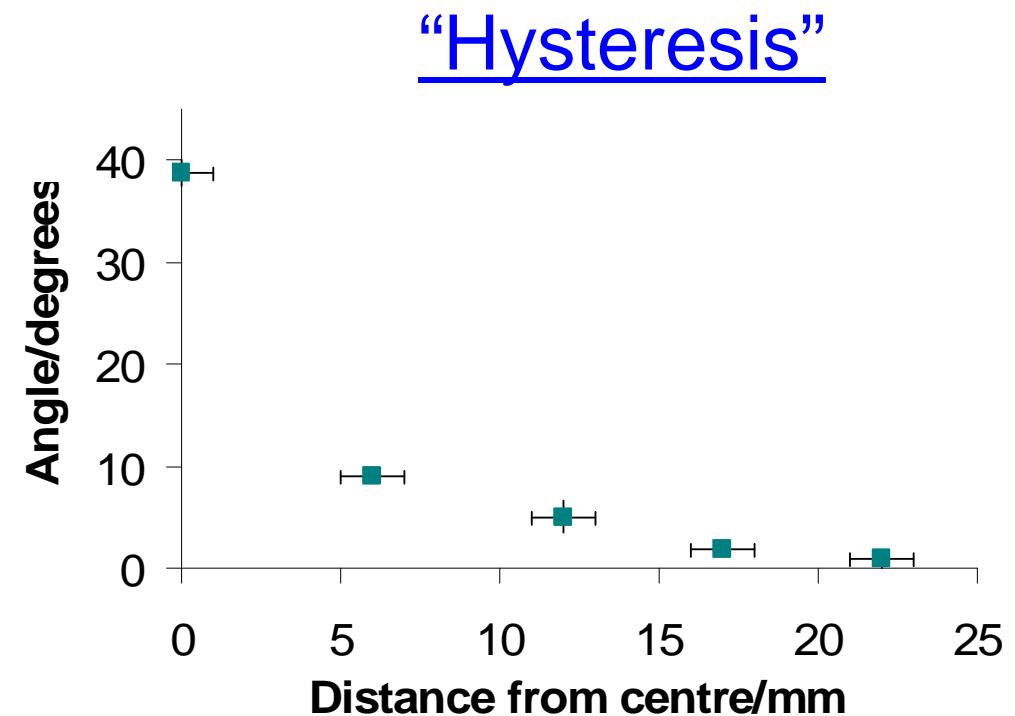
## Mechanism for Motion

Small slope on extremely low hysteresis surface?

Truly contact angle driven?



Multiple profiles have been taken along different radial lines



Using radial view and tilt table tangential to radius

# Electrowetting on a Superhydrophobic Surface

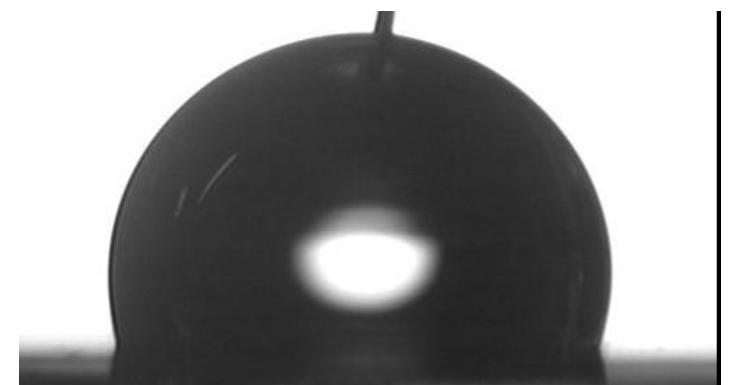
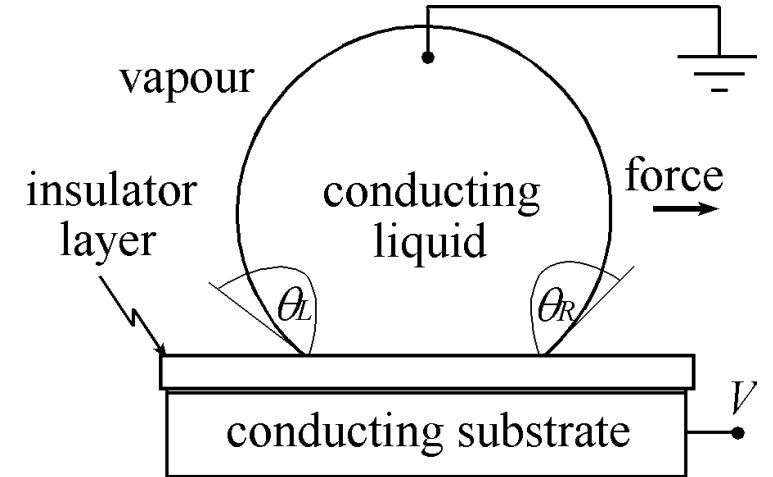
# Electrowetting-on-Dielectric (EWOD)

## Electrowetting Principle

- Conducting liquid on electrical insulator on conducting substrate
- Applying voltage electrically charges solid-liquid interface (i.e. a Capacitive effect)
- Droplet spreads and contact angle reduces

$$\cos \theta_e(V) = \cos \theta_e(0) + CV^2 / 2 \gamma_{LV}$$

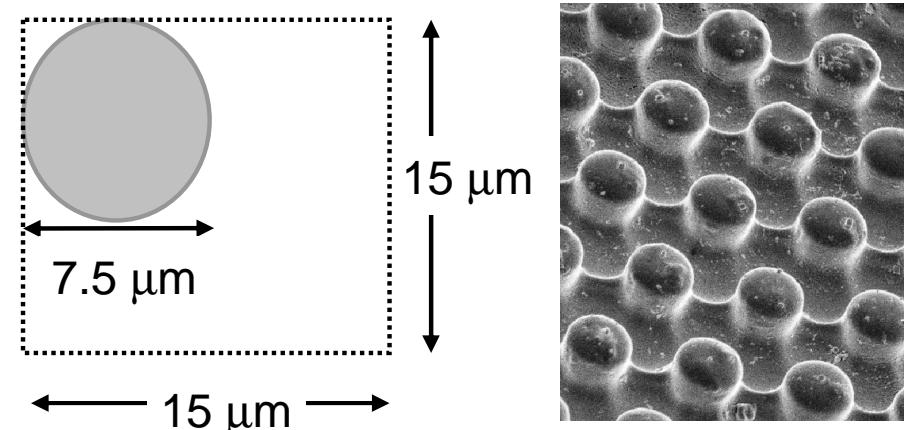
- Difference in angles at edge of droplet reflects an actuating force



# Irreversible Electrowetting on S/H Surface

## Lithographic System

- Ti/Au on glass, SU-8 microposts, Teflon AF1600 capped
- Droplets of deionised water with 0.01M KCl and AC or DC



Initial Shape



Applied Voltage



Voltage Removed



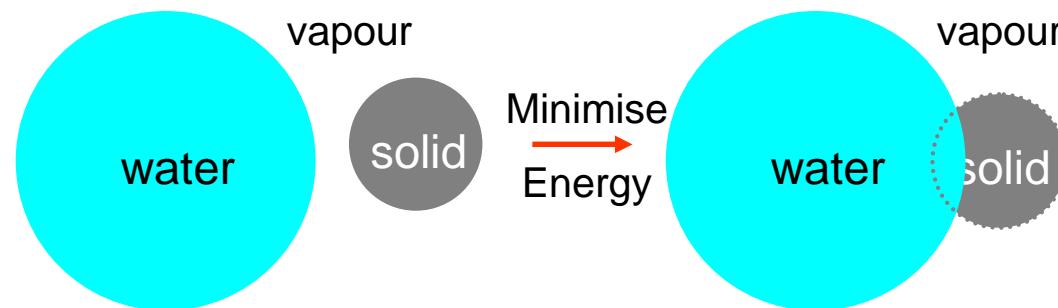
152° —————→ 114°

*Irreversible and so difficult for actuating motion*

# Liquid Marbles

# Liquid Marbles

- Hydrophobic Grains Adhere to the Water-Air Interface



$$\Delta F = -\pi R_g^2 \gamma_L (1 + \cos \theta_e)^2$$

## Lycopodium



Lycopodium grains are 15-19  $\mu\text{m}$ , but monolayers can be achieved



Perfect non-wetting system with zero hysteresis  
Gravity flattens shape as volume increases

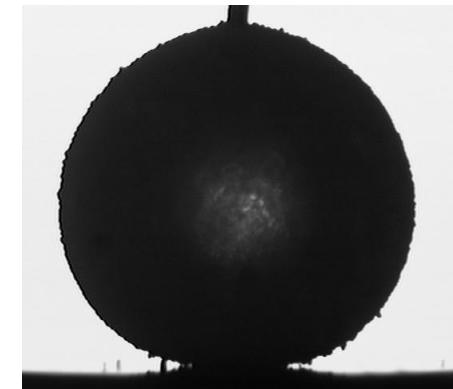


# Active Actuation of Marble Motion

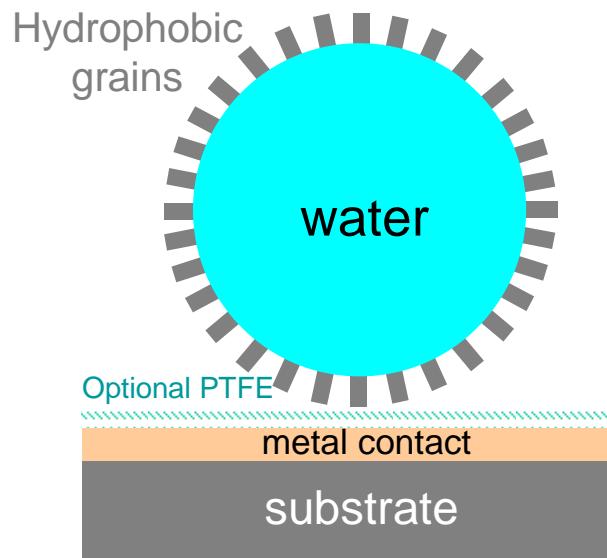
# “Electrowetting” of Liquid Marbles

- **Reversibility Idea**

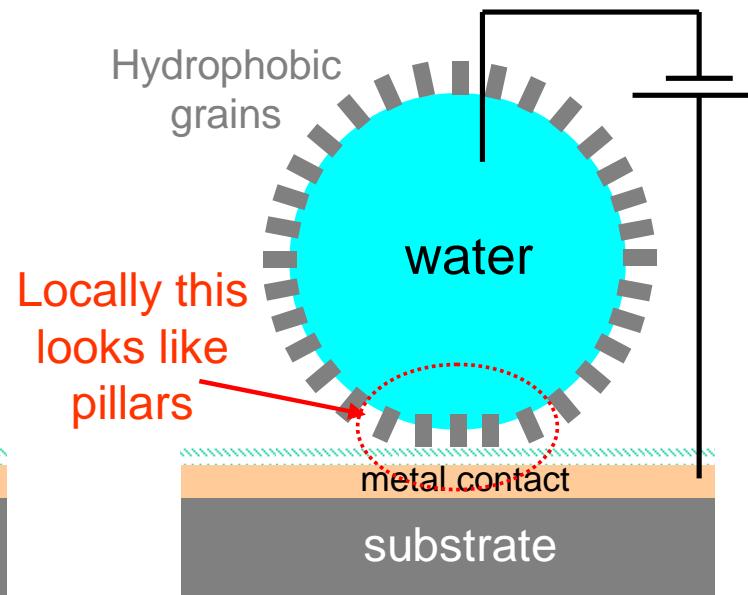
- Make the solid “pillars” adhere more to the liquid than to the substrate
- Provides insulating “pillars” conformal to the liquid shape
- More hydrophobic grains “stick out” further (i.e. taller pillars)



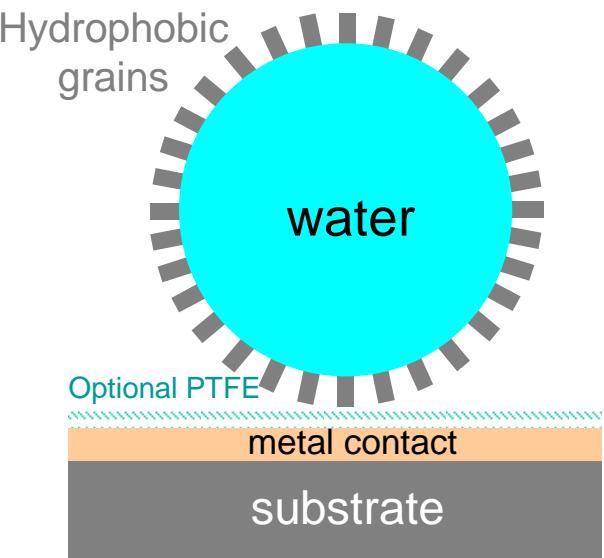
## Initial Shape



## Apply Voltage



## Remove Voltage



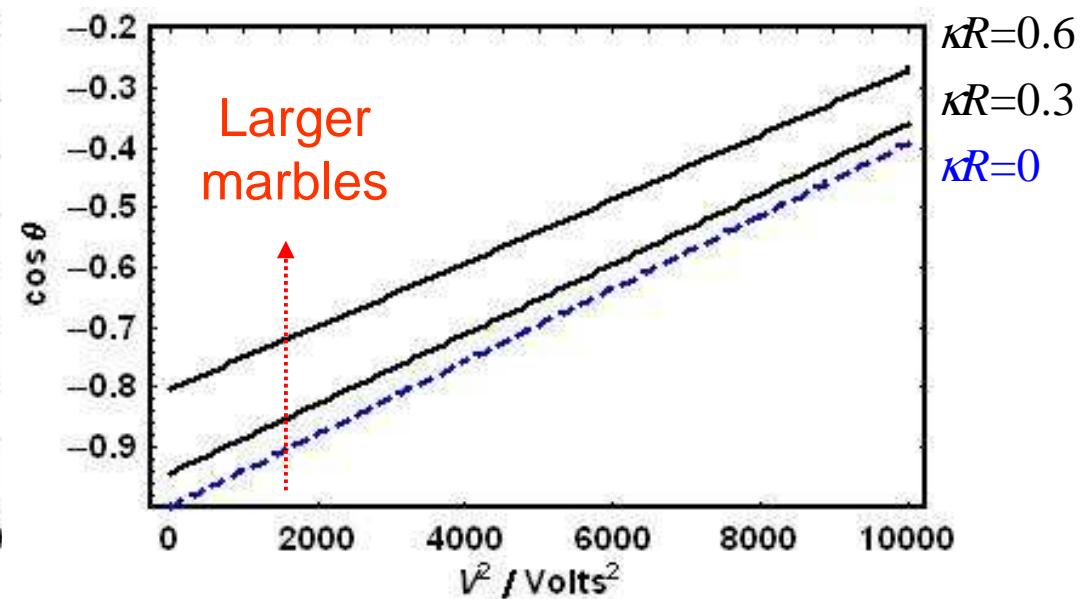
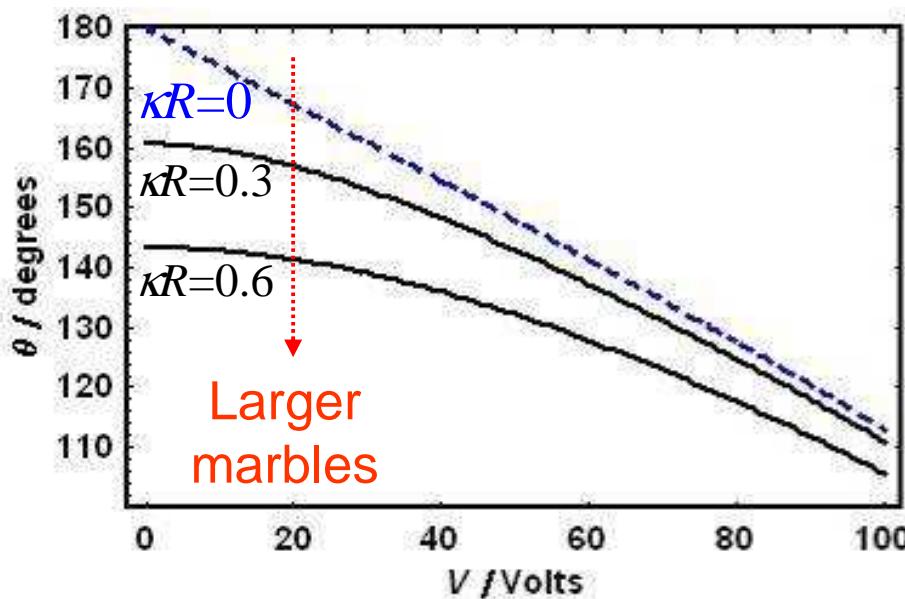
# Model for Liquid Marbles

Minimise total energy of a spherical cap

$$\cos \theta = \cos \theta_e + (\kappa h)^2 / 6 + CV^2 / 2 \gamma_{LV}$$

From surface energy -1 for marble      Gravitational energy gives a drop size factor with  $h = h(\theta)$ , so non-linear      Capacitive energy from electrowetting

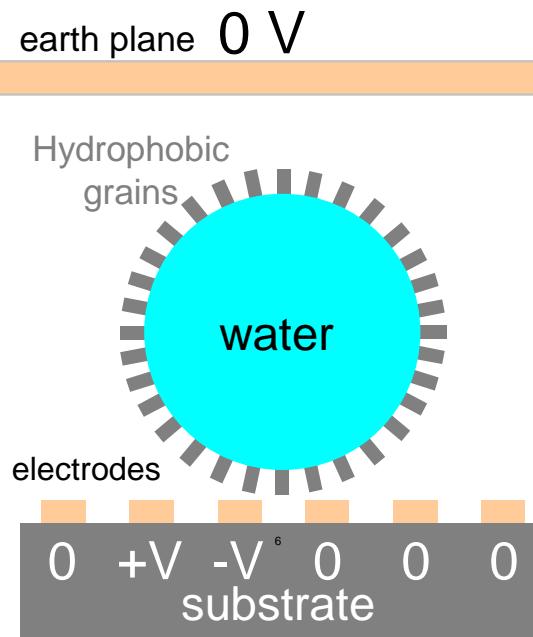
## Numerical Results



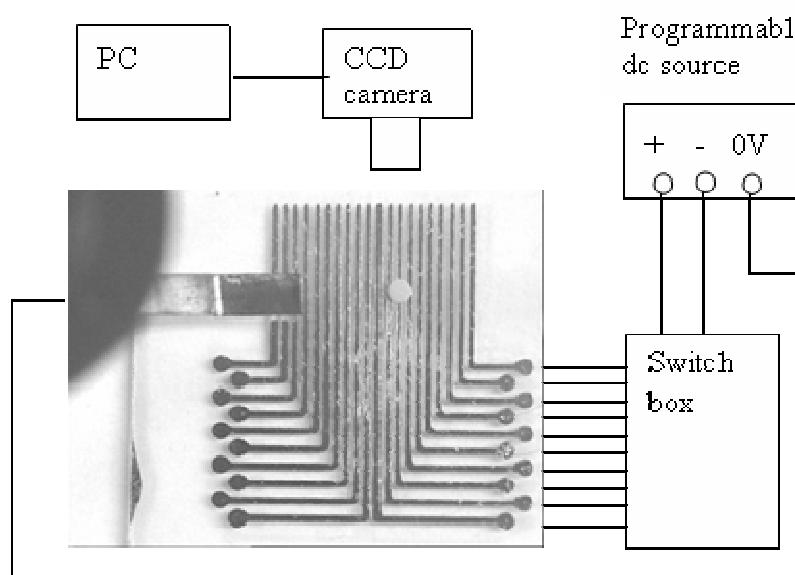
# A Hint of Controllable Motion

1. Liquid marble using hydrophobic lycopodium
2. Upper earth plane, planar strip electrodes, pairs switched to  $\pm 150$  V DC

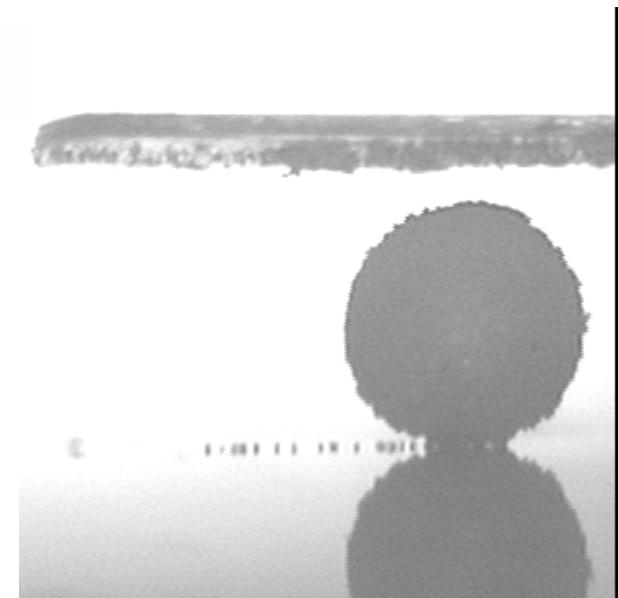
## Concept



## Method



## Results



# Summary

## 1. Passively Actuated Motion of Droplets

Appears possible via gradients in  $\theta_{CB}$

Outstanding questions about droplet threshold sizes

## 2. Voltage Actuated Motion

Problems remain on superhydrophobic surfaces

Can be achieved with liquid marbles

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The End

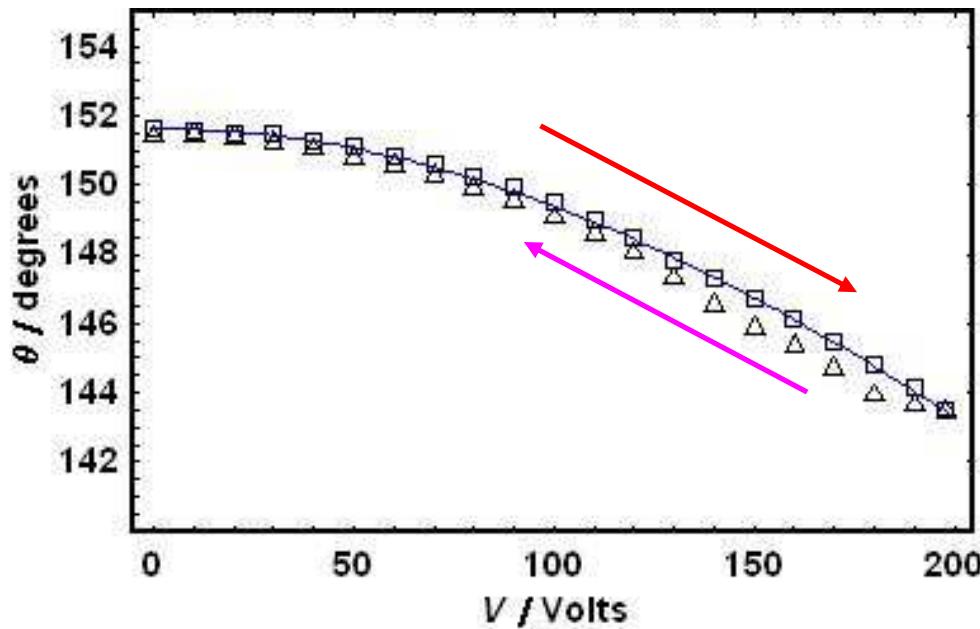
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### Acknowledgements

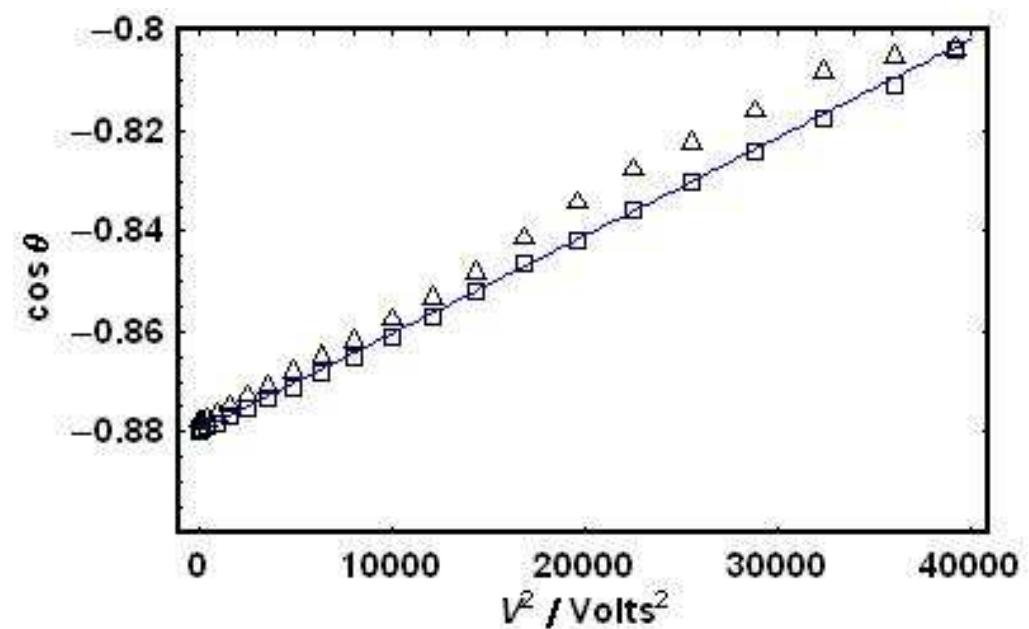
EPSRC GR/R02184/01 and GR/S34168/01 –Dstl via  
EPSRC/MOD JGS  
EU COST Action D19 & P21

## 5. Results using Hydrophobic Silica

### Contact Angle

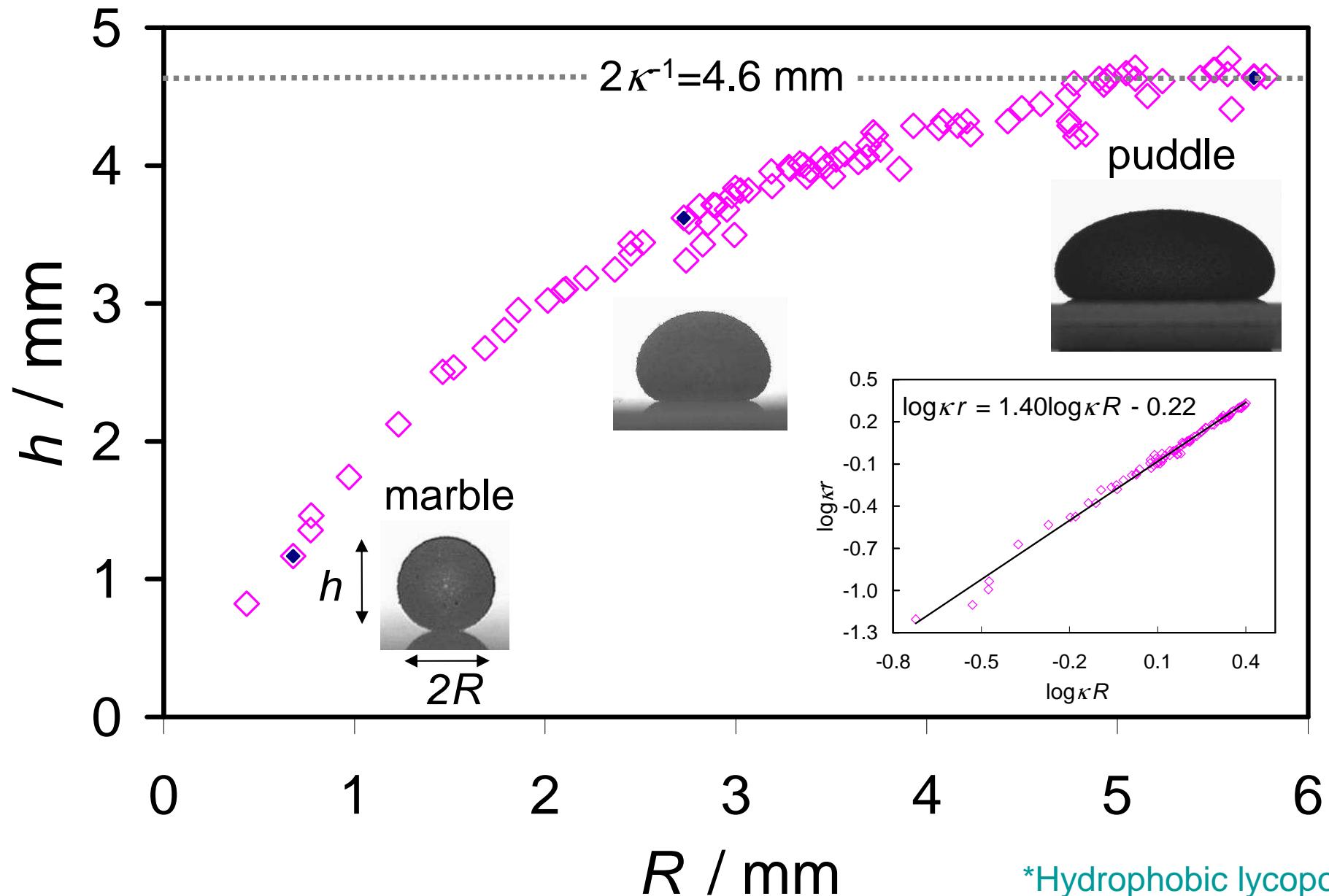


### Fitting



1. *No threshold* voltage
2. Virtually *no* contact angle *hysteresis*
3. Experiments show a limited range ( $155^\circ$  to  $130^\circ$ )
4. Fit uses  $\kappa R=0.45$

# Perfect Non-Wetting Marbles\*



# Electroplated Copper Surfaces

- Copper acid bath

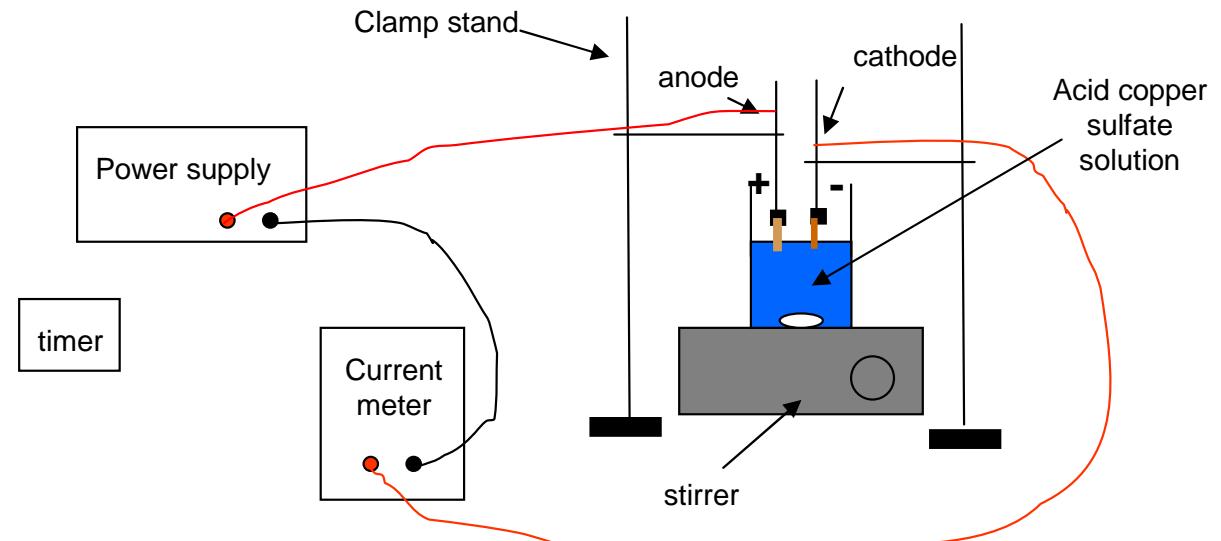
Copper sulphate ( $\text{CuSO}_4$ ) and sulphuric acid ( $\text{H}_2\text{SO}_4$ )

## Current density

Slightly rough to highly  
rough (Fractal)

## Masking

Mask and grow pillars  
in Cu on Cu



*Setup for the copper plating*